

## 8-Channel Multiplexer, with 0.5 pC Charge Injection

### DESCRIPTION

The DG9451 is a precision low voltage, single and dual supply CMOS analog 8-channel multiplexer.

The DG9451 is designed to operate from a + 2.7 V to + 12 V single supply or from  $\pm 5$  V dual supplies and is fully specified at + 12 V, + 5 V and  $\pm 5$  V. All control logic inputs have guaranteed 1.4 V high limit when operating from + 5 V or  $\pm 5$  V supplies and 1.6 V when operating from a + 12 V supply.

The DG9451 switches conduct equally well in both directions, offer rail to rail analog signal handling and can be used both as multiplexers as well as de-multiplexers.

< 0.5 pC low charge injection coupled with very low switch capacitance make these products ideal for precision instrumentation multiplexers.

Operating temperature is specified from - 40 °C to + 125 °C.

The DG9451 is available in the space saving 1.8 mm x 2.6 mm miniQFN package.

### FEATURES

- **Halogen-free According to IEC 61249-2-21 Definition**
- + 2.7 V to + 12 V single supply operation
- $\pm 2.5$  V to  $\pm 5$  V dual supply operation
- Fully specified at + 12 V, + 5 V,  $\pm 5$  V
- 100  $\Omega$  maximum on-resistance
- Low voltage
- Low charge injection (< 0.5 pC typ.)
- High bandwidth: 270 MHz
- Low switch capacitance ( $C_{S(off)}$  1 pF typ.)
- Excellent isolation and crosstalk performance (typ. - 44 dB at 100 MHz)
- MiniQFN package (1.8 mm x 2.6 mm)
- Fully specified from - 40 °C to + 85 °C and - 40 °C to + 125 °C
- Compliant to RoHS directive 2002/95/EC

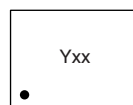
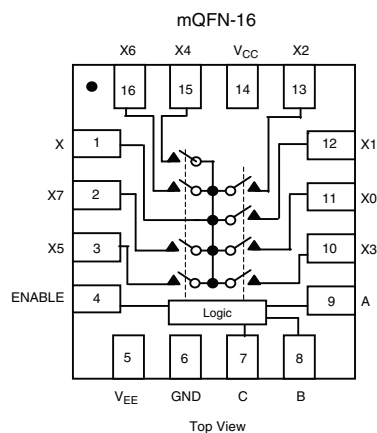


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Precision instrumentation
- Sample and hold applications
- Medical instruments
- High speed communication applications
- Automated test equipment
- High-end data acquisition

### FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



Pin 1

Device Marking: Yxx for DG9451  
(miniQFN16)

xx = Date/Lot Traceability Code



TRUTH TABLE				
Enable Input	Select Inputs			On Switches
	C	B	A	DG9451
H	X	X	X	All Switches Open
L	L	L	L	X to X0
L	L	L	H	X to X1
L	L	H	L	X to X2
L	L	H	H	X to X3
L	H	L	L	X to X4
L	H	L	H	X to X5
L	H	H	L	X to X6
L	H	H	H	X to X7

ORDERING INFORMATION		
Temp. Range	Package	Part Number
DG9451		
- 40 °C to 125 °C <sup>a</sup>	16-Pin miniQFN	DG9451EN-T1-E4

Notes:

a. - 40 °C to 85 °C datasheet limits apply.

ABSOLUTE MAXIMUM RATINGS $T_A = 25\text{ °C}$ , unless otherwise noted			
Parameter		Limit	Unit
V+ to V-		14	V
GND to V-		7	
Digital Inputs <sup>a</sup> , V <sub>S</sub> , V <sub>D</sub>		(V-) - 0.3 to (V+) + 0.3 or 30 mA, whichever occurs first	
Continuous Current (Any terminal)		30	mA
Peak Current, S or D (Pulsed 1 ms, 10 % duty cycle)		100	
Storage Temperature		- 65 to 150	°C
Power Dissipation <sup>b</sup>	16-Pin miniQFN <sup>c, d</sup>	525	mW
Thermal Resistance <sup>b</sup>	16-Pin miniQFN <sup>d</sup>	152	°C/W
Latch-up (per JESD78)		> 300	mA

Notes:

a. Signals on SX, DX, or INX exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC board.

c. Derate 6.6 mW/°C above 70 °C.

d. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

<b>SPECIFICATIONS FOR DUAL SUPPLIES</b>										
Parameter	Symbol	Test Conditions Unless Otherwise Specified $V_{CC} = +5\text{ V}$ , $V_{EE} = -5\text{ V}$ $V_{IN(A, B, C \text{ and } ENABLE)} = 1.4\text{ V}$ , $0.3\text{ V}^a$		Temp. <sup>b</sup>	Typ. <sup>c</sup>	- 40 °C to 125 °C		- 40 °C to 85 °C		Unit
		Min. <sup>d</sup>	Max. <sup>d</sup>			Min. <sup>d</sup>	Max. <sup>d</sup>			
<b>Analog Switch</b>										
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$			Full		- 5	5	- 5	5	V
On-Resistance	$R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = -3\text{ V}$ , $0\text{ V}$ , $+3\text{ V}$		Room Full	66		100 125		100 118	$\Omega$
On-Resistance Match	$\Delta R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = \pm 3\text{ V}$		Room Full	3		6 10		6 8	
On-Resistance Flatness	$R_{FLATNESS}$	$I_S = 1\text{ mA}$ , $V_D = -3\text{ V}$ , $0\text{ V}$ , $+3\text{ V}$		Room Full	10.2		16 20		16 18	
Switch Off Leakage Current	$I_{S(off)}$	$V_+ = 5.5\text{ V}$ , $V_- = -5.5\text{ V}$ , $V_D = \pm 4.5\text{ V}$ , $V_S = \mp 4.5\text{ V}$		Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	nA
	$I_{D(off)}$			Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
Channel On Leakage Current	$I_{D(on)}$	$V_+ = 5.5\text{ V}$ , $V_- = -5.5\text{ V}$ , $V_S = V_D = \pm 4.5\text{ V}$		Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
<b>Digital Control</b>										
$V_{IN(A, B, C \text{ and } ENABLE)}$ Low	$V_{IL}$			Full			0.3		0.3	V
$V_{IN(A, B, C \text{ and } ENABLE)}$ High	$V_{IH}$			Full		1.4		1.4		
Input Current, $V_{IN}$ Low	$I_{IL}$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $0.3\text{ V}$		Full	0.01	- 1	1	- 1	1	$\mu\text{A}$
Input Current, $V_{IN}$ High	$I_{IH}$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $1.4\text{ V}$		Full	0.01	- 1	1	- 1	1	
Input Capacitance <sup>e</sup>	$C_{IN}$	$f = 1\text{ MHz}$		Room	3.4					pF
<b>Dynamic Characteristics</b>										
Transition Time	$t_{TRANS}$	$R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ see figure 1, 2, 3		Room Full	66		180 218		180 207	ns
Enable Turn-On Time	$t_{ON}$			Room Full	152		250 295		250 282	
Enable Turn-Off Time	$t_{OFF}$			Room Full	60		125 136		125 131	
Break-Before-Make Time Delay	$t_D$			Room Full	32		13		13	
Off Isolation <sup>e</sup>	OIRR	$R_L = 50\ \Omega$ , $C_L = 15\text{ pF}$		$f = 100\text{ kHz}$	Room	< - 90				dB
				$f = 10\text{ MHz}$	Room	- 65				
Channel-to-Channel Crosstalk <sup>e</sup>	$X_{TALK}$			$f = 100\text{ MHz}$	Room	- 44				
				$f = 100\text{ kHz}$	Room	< - 90				
				$f = 10\text{ MHz}$	Room	- 74				
				$f = 100\text{ MHz}$	Room	- 44				
Bandwidth, 3 dB	BW	$R_L = 50\ \Omega$		Room	270				MHz	
Charge Injection <sup>e</sup>	Q	$V_g = 0\text{ V}$ , $R_g = 0\ \Omega$ , $C_L = 1\text{ nF}$		Room	0.20				pC	
Source Off Capacitance <sup>e</sup>	$C_{S(off)}$	$f = 1\text{ MHz}$		Room	1				pF	
Drain Off Capacitance <sup>e</sup>	$C_{D(off)}$			Room	10					
Channel On Capacitance <sup>e</sup>	$C_{D(on)}$			Room	16					
Total Harmonic Distortion <sup>e</sup>	THD	Signal = $1\text{ V}_{RMS}$ , 20 Hz to 20 kHz, $R_L = 600\ \Omega$		Room	0.01				%	
<b>Power Supplies</b>										
Power Supply Current	$I_+$	$V_{CC} = +5\text{ V}$ , $V_{EE} = -5\text{ V}$ $V_{IN(A, B, C \text{ and } ENABLE)} = 0$ or $5\text{ V}$		Room Full	0.05		1 10		1 10	$\mu\text{A}$
Negative Supply Current	$I_-$			Room Full	- 0.05	- 1 - 10		- 1 - 10		
Ground Current	$I_{GND}$			Room Full	- 0.05	- 1 - 10		- 1 - 10		

SPECIFICATIONS FOR UNIPOLAR SUPPLIES									
Parameter	Symbol	Test Conditions Unless Otherwise Specified $V_{CC} = +5\text{ V}$ , $V_{EE} = 0\text{ V}$ $V_{IN(A, B, C \text{ and } ENABLE)} = 1.4\text{ V}$ , $0.3\text{ V}^a$	Temp. <sup>b</sup>	Typ. <sup>c</sup>	- 40 °C to 125 °C		- 40 °C to 85 °C		Unit
					Min. <sup>d</sup>	Max. <sup>d</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	
<b>Analog Switch</b>									
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$		Full		0	5	0	5	V
On-Resistance	$R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = 0\text{ V}$ , $+3.5\text{ V}$	Room Full	105		165 205		165 194	Ω
On-Resistance Match	$\Delta R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = +3.5\text{ V}$	Room Full	3.2		8 13		8 10	
On-Resistance Flatness	$R_{FLATNESS}$	$I_S = 1\text{ mA}$ , $V_D = 0\text{ V}$ , $+3\text{ V}$	Room Full	17		26 30		26 28	
Switch Off Leakage Current	$I_{S(off)}$	$V_+ = +5.5\text{ V}$ , $V_- = 0\text{ V}$ $V_D = 1\text{ V}/4.5\text{ V}$ , $V_S = 4.5\text{ V}/1\text{ V}$	Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	nA
	$I_{D(off)}$		Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
Channel On Leakage Current	$I_{D(on)}$	$V_+ = +5.5\text{ V}$ , $V_- = 0\text{ V}$ $V_D = V_S = 1\text{ V}/4.5\text{ V}$	Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
<b>Digital Control</b>									
$V_{IN(A, B, C \text{ and } ENABLE)}$ Low	$V_{IL}$		Full			0.3		0.3	V
$V_{IN(A, B, C \text{ and } ENABLE)}$ High	$V_{IH}$		Full		1.4		1.4		
Input Current, $V_{IN}$ Low	$I_L$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $0.3\text{ V}$	Full	0.01	- 1	1	- 1	1	μA
Input Current, $V_{IN}$ High	$I_H$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $1.4\text{ V}$	Full	0.01	- 1	1	- 1	1	
<b>Dynamic Characteristics</b>									
Transition Time	$t_{TRANS}$	$R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ See Figure 1, 2, 3	Room Full	79		205 295		205 285	ns
Enable Turn-On Time	$t_{ON}$		Room Full	220		335 403		335 393	
Enable Turn-Off Time	$t_{OFF}$		Room Full	93		150 173		150 163	
Break-Before-Make Time Delay	$t_D$		Room Full	36		20		20	
Charge Injection <sup>e</sup>	Q	$V_g = 0\text{ V}$ , $R_g = 0\ \Omega$ , $C_L = 1\text{ nF}$	Full	0.81					pC
Off Isolation <sup>e</sup>	OIRR	$R_L = 50\ \Omega$ , $C_L = 15\text{ pF}$ $f = 100\text{ kHz}$	Room	< - 90					dB
Channel-to-Channel Crosstalk <sup>e</sup>	$X_{TALK}$		Room	< - 90					
Source Off Capacitance <sup>e</sup>	$C_{S(off)}$	f = 1 MHz	Room	1					pF
Drain Off Capacitance <sup>e</sup>	$C_{D(off)}$		Room	11					
Channel On Capacitance <sup>e</sup>	$C_{D(on)}$		Room	17					
<b>Power Supplies</b>									
Power Supply Current	I+	$V_{IN(A, B, C \text{ and } ENABLE)} = 0\text{ V}$ or $5\text{ V}$	Room Full	0.05		1 10		1 10	μA
Negative Supply Current	I-		Room Full	- 0.05	- 1 - 10		- 1 - 10		
Ground Current	$I_{GND}$		Room Full	- 0.05	- 1 - 10		- 1 - 10		

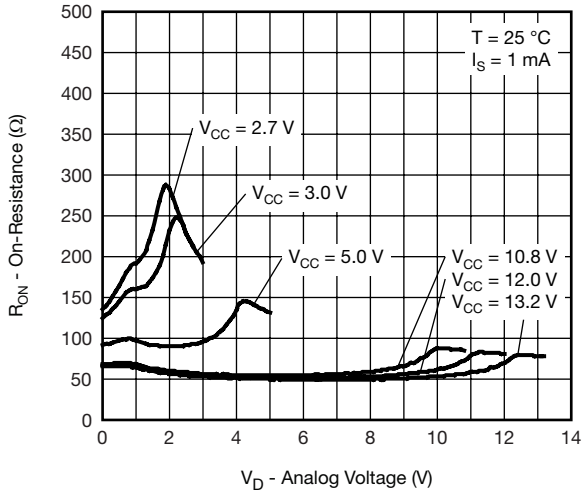
SPECIFICATIONS FOR UNIPOLAR SUPPLIES									
Parameter	Symbol	Test Conditions Unless Otherwise Specified $V_{CC} = +12\text{ V}$ , $V_{EE} = 0\text{ V}$ $V_{IN(A, B, C \text{ and } ENABLE)} = 1.6\text{ V}$ , $0.5\text{ V}^a$	Temp. <sup>b</sup>	Typ. <sup>c</sup>	- 40 °C to 125 °C		- 40 °C to 85 °C		Unit
					Min. <sup>d</sup>	Max. <sup>d</sup>	Min. <sup>d</sup>	Max. <sup>d</sup>	
<b>Analog Switch</b>									
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$		Full		0	12	0	12	V
On-Resistance	$R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = 0.7\text{ V}$ , $6.0\text{ V}$ , $11.3\text{ V}$	Room Full	68		105 143		105 137	$\Omega$
On-Resistance Match	$\Delta R_{ON}$	$I_S = 1\text{ mA}$ , $V_D = +0.7\text{ V}$	Room Full	4		7 10		7 8	
On-Resistance Flatness	$R_{FLATNESS}$	$I_S = 1\text{ mA}$ , $V_D = 0.7\text{ V}$ , $+11.3\text{ V}$	Room Full	32		45 49		45 47	
Switch Off Leakage Current	$I_{S(off)}$	$V_+ = +12\text{ V}$ , $V_- = 0\text{ V}$ $V_D = 1\text{ V}/11\text{ V}$ , $V_S = 11\text{ V}/1\text{ V}$	Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	nA
	$I_{D(off)}$		Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
Channel On Leakage Current	$I_{D(on)}$	$V_+ = +12\text{ V}$ , $V_- = 0\text{ V}$ $V_D = V_S = 1\text{ V}/11\text{ V}$	Room Full	$\pm 0.02$	- 1 - 50	1 50	- 1 - 5	1 5	
<b>Digital Control</b>									
$V_{IN(A, B, C \text{ and } ENABLE)}$ Low	$V_{IL}$		Full			0.5		0.5	V
$V_{IN(A, B, C \text{ and } ENABLE)}$ High	$V_{IH}$		Full		1.6		1.6		
Input Current, $V_{IN}$ Low	$I_L$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $0.5\text{ V}$	Full	0.01	- 1	1	- 1	1	$\mu\text{A}$
Input Current, $V_{IN}$ High	$I_H$	$V_{IN(A, B, C \text{ and } ENABLE)}$ under test = $1.6\text{ V}$	Full	0.01	- 1	1	- 1	1	
<b>Dynamic Characteristics</b>									
Transition Time	$t_{TRANS}$	$R_L = 300\ \Omega$ , $C_L = 35\text{ pF}$ see figure 1, 2, 3	Room Full	55		135 166		135 155	ns
Enable Turn-On Time	$t_{ON}$		Room Full	106		185 219		185 205	
Enable Turn-Off Time	$t_{OFF}$		Room Full	65		130 144		130 137	
Break-Before-Make Time Delay	$t_D$		Room Full	30		12		12	
Charge Injection <sup>e</sup>	Q	$V_g = 0\text{ V}$ , $R_g = 0\ \Omega$ , $C_L = 1\text{ nF}$	Room	0.79					pC
Off Isolation <sup>e</sup>	OIRR	$R_L = 50\ \Omega$ , $C_L = 15\text{ pF}$ $f = 100\text{ kHz}$	Room	< - 90					dB
Channel-to-Channel Crosstalk <sup>e</sup>	$X_{TALK}$		Room	< - 90					
Source Off Capacitance <sup>e</sup>	$C_{S(off)}$	$f = 1\text{ MHz}$	Room	1					pF
Drain Off Capacitance <sup>e</sup>	$C_{D(off)}$		Room	9					
Channel On Capacitance <sup>e</sup>	$C_{D(on)}$		Room	15					
<b>Power Supplies</b>									
Power Supply Current	I+	$V_{IN(A, B, C \text{ and } ENABLE)} = 0\text{ V}$ or $12\text{ V}$	Room Full	0.05		1 10		1 10	$\mu\text{A}$
Negative Supply Current	I-		Room Full	- 0.05	- 1 - 10		- 1 - 10		
Ground Current	$I_{GND}$		Room Full	- 0.05	- 1 - 10		- 1 - 10		

**Notes:**

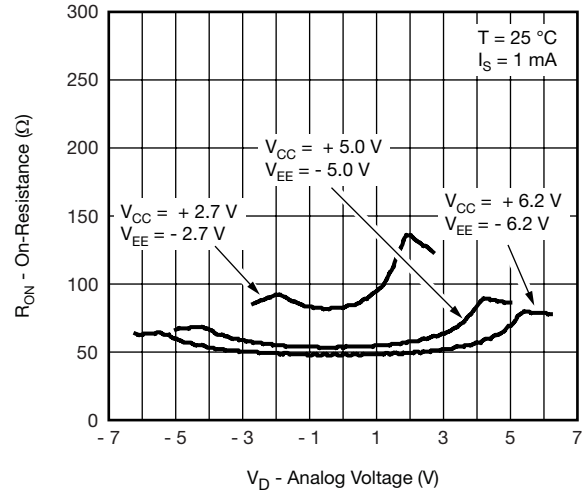
- $V_{IN}$  = input voltage to perform proper function.
- Room - 25 °C, Full = as determined by the operating temperature suffix.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- Guaranteed by design, not subject to production test.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

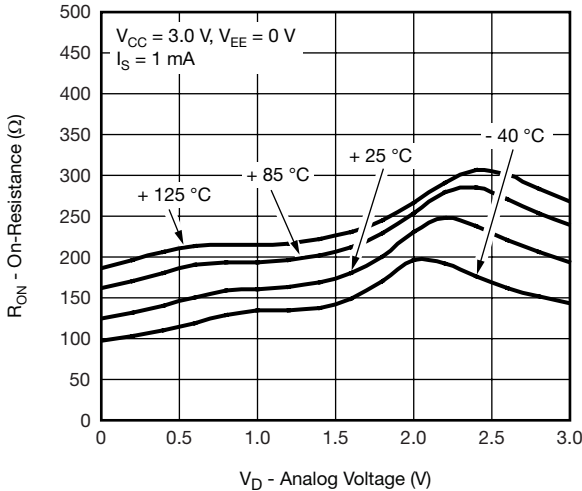
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



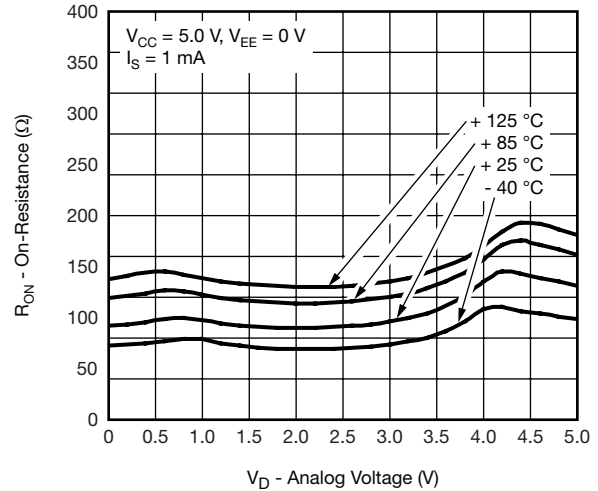
**On-Resistance vs.  $V_D$  and Signal Supply Voltage**



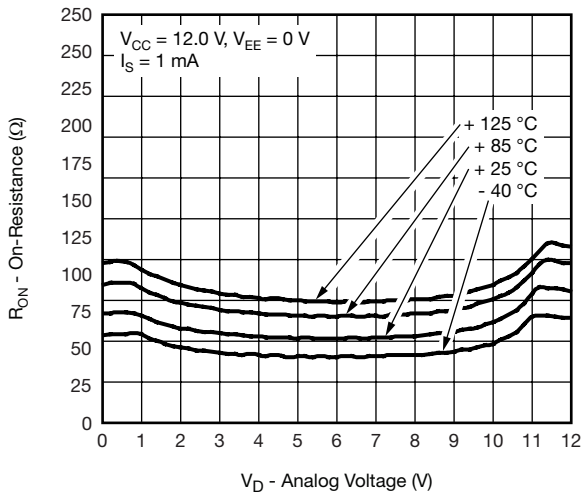
**On-Resistance vs. Analog Voltage and Temperature**



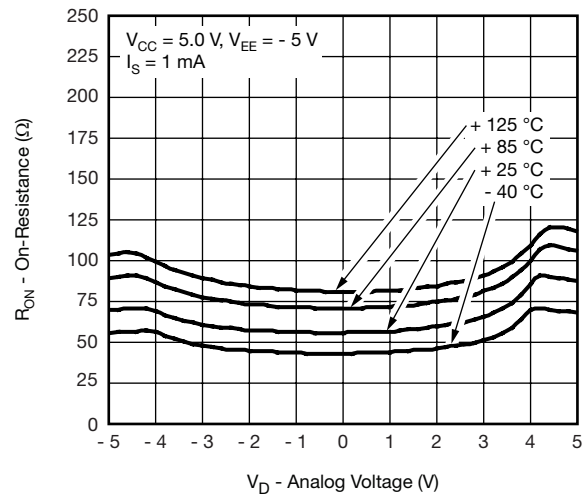
**On-Resistance vs. Analog Voltage and Temperature**



**On-Resistance vs. Analog Voltage and Temperature**

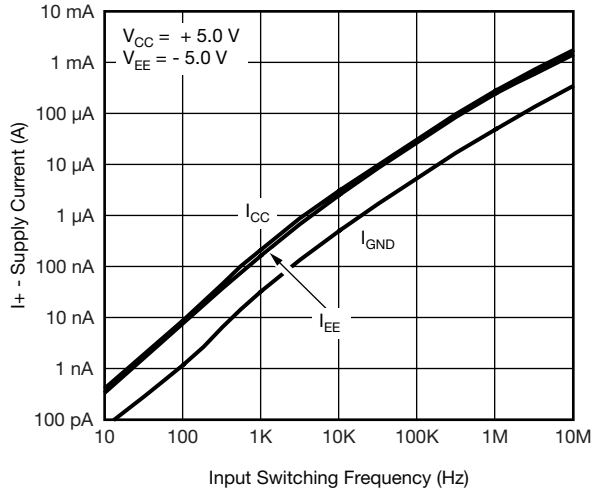


**On-Resistance vs. Analog Voltage and Temperature**

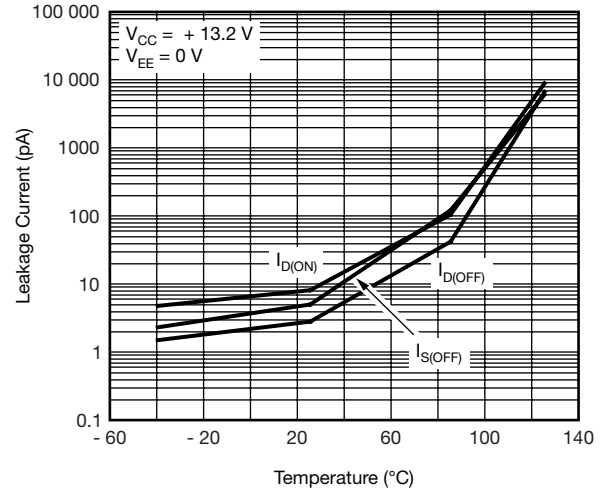


**On-Resistance vs. Analog Voltage and Temperature**

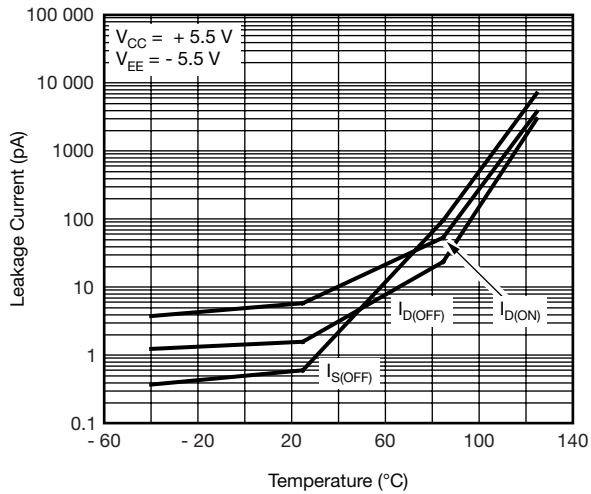
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



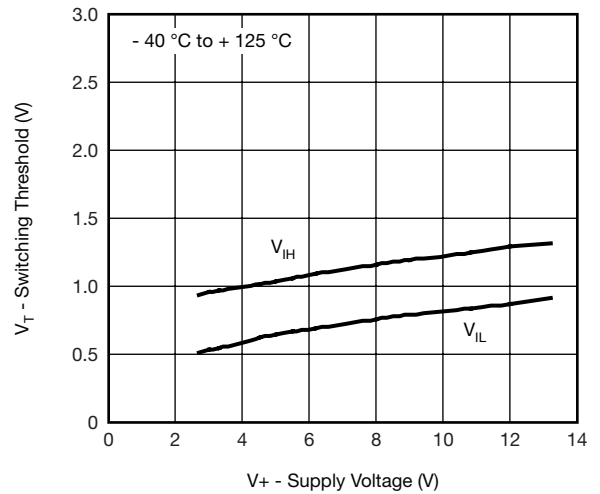
**Supply Current vs. Input Switching Frequency**



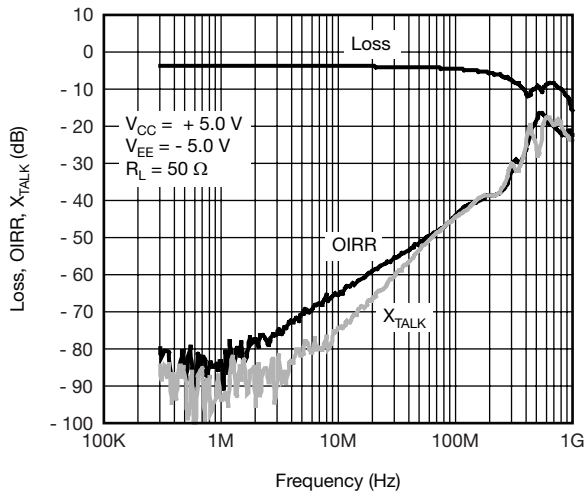
**Leakage Current vs. Temperature**



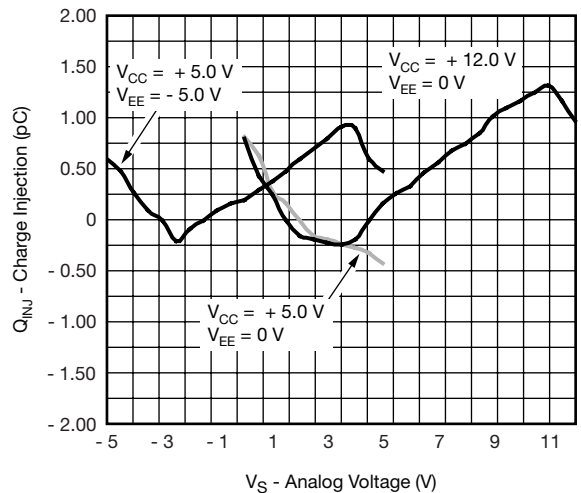
**Leakage Current vs. Temperature**



**Switching Threshold vs. Supply Voltage**

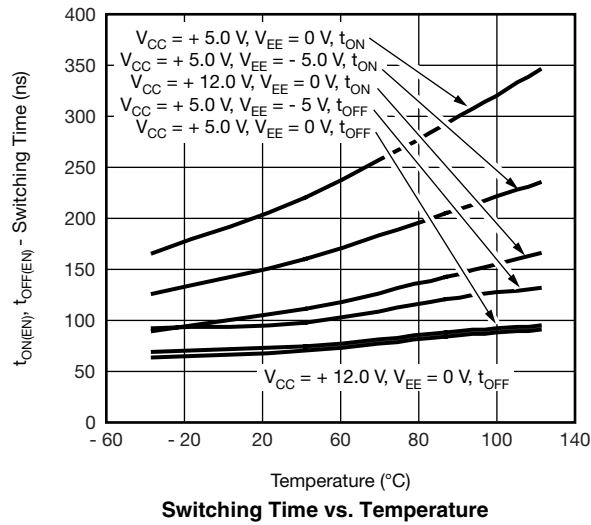


**Insertion Loss, Off-Isolation, Crosstalk vs. Frequency**



**Charge Injection vs. Analog Voltage**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**TEST CIRCUITS**

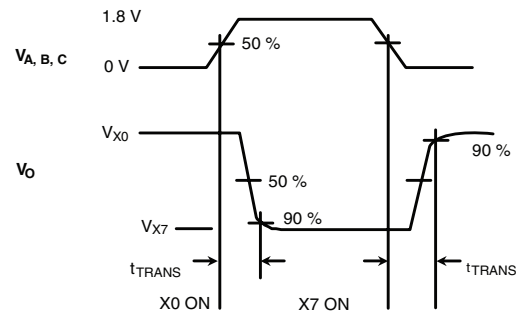
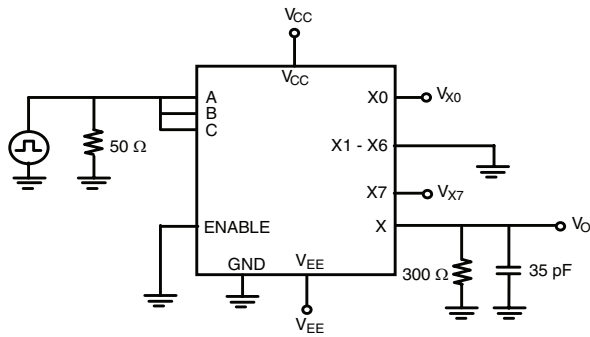


Figure 1. Transition Time

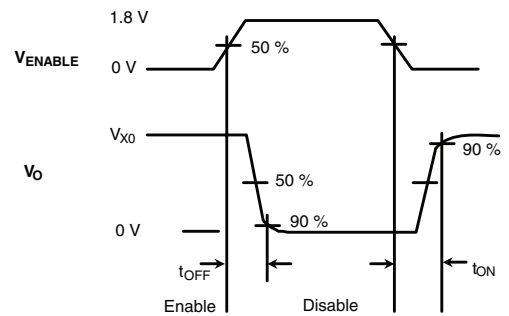
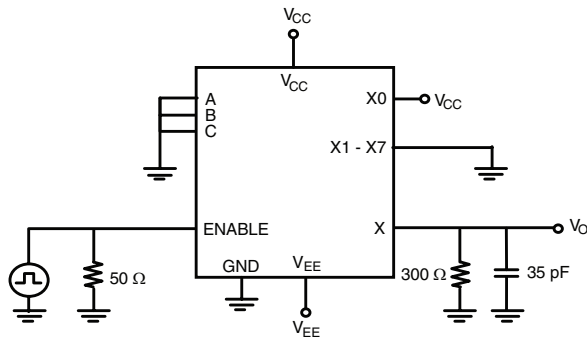
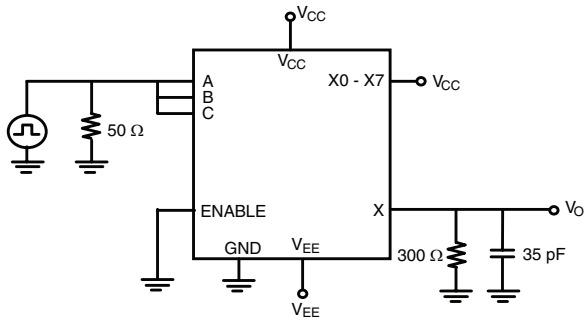
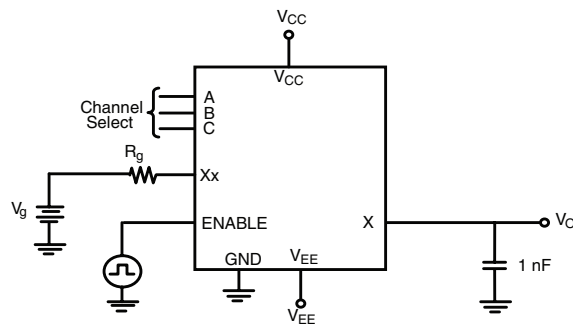
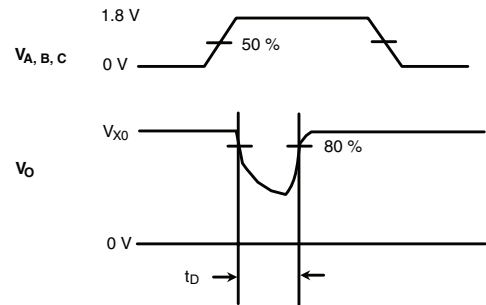
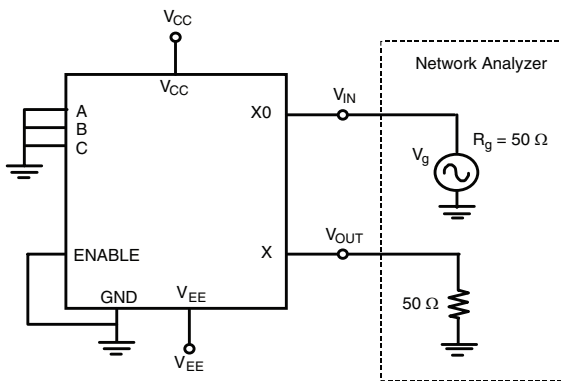
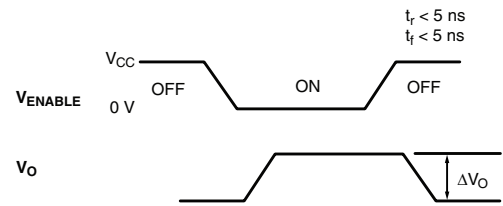
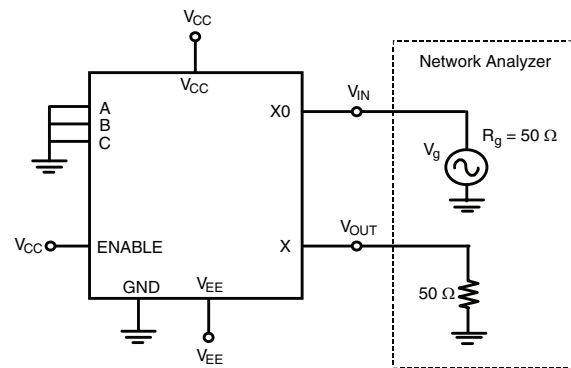


Figure 2. Enable Switching Time



**TEST CIRCUITS**

**Figure 3. Break-Before-Make**

**Figure 4. Charge Injection**


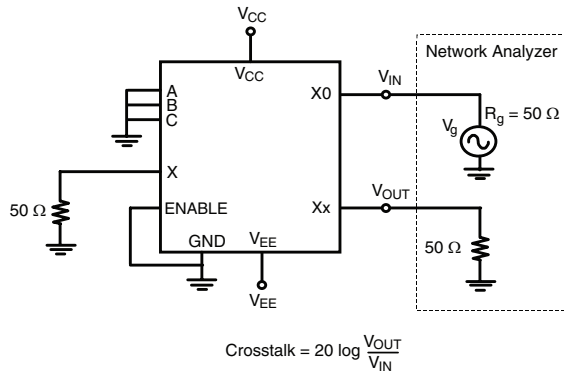
$$\text{Insertion Loss} = 20 \log \frac{V_{\text{OUT}}}{V_{\text{IN}}}$$

**Figure 5. Insertion Loss**


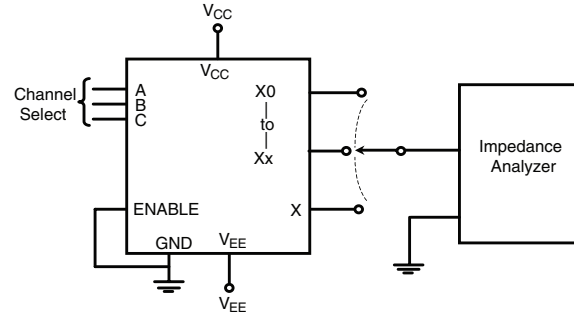
$$\text{Off Isolation} = 20 \log \frac{V_{\text{OUT}}}{V_{\text{IN}}}$$

**Figure 6. Off Isolation**

**TEST CIRCUITS**



**Figure 7. Crosstalk**



**Figure 8. Source, Drain Capacitance**

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